L	Hits	Search Text	DB	Time stamp
Number				_
64	27448	<pre>((light-emitting) (light near emitting)) and (recess trench gap cavity opening groove) and sensor</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/17 15:38
65	1714296	optical lens	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2003/10/17 15:40
66	19649	(((light-emitting) (light near emitting)) and (recess trench gap cavity opening groove) and sensor ) and (optical lens)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/10/17 15:40
67	4736655	substrate wafer base (auxiliary near carrier)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/10/17 15:43
68	14795	<pre>((((light-emitting) (light near emitting)) and (recess trench gap cavity opening groove) and sensor ) and (optical lens)) and (substrate wafer base (auxiliary near carrier))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/10/17 16:34
72	22621	optoelectronic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/10/17 16:34
73	647	<pre>(((((light-emitting) (light near emitting)) and (recess trench gap cavity opening groove) and sensor ) and (optical lens)) and (substrate wafer base (auxiliary near carrier))) and optoelectronic</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/17 16:34